

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Xuezhe Zheng</td> <td>01/13/2010</td> </tr> <tr> <td>Ashok V. Krishnamoorthy</td> <td>01/13/2010</td> </tr> <tr> <td>John E. Cunningham</td> <td>01/13/2010</td> </tr> </tbody> </table>		Name	Execution Date	Xuezhe Zheng	01/13/2010	Ashok V. Krishnamoorthy	01/13/2010	John E. Cunningham	01/13/2010		
Name	Execution Date										
Xuezhe Zheng	01/13/2010										
Ashok V. Krishnamoorthy	01/13/2010										
John E. Cunningham	01/13/2010										
RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>SUN MICROSYSTEMS, INC.</td> </tr> <tr> <td>Street Address:</td> <td>4150 Network Circle</td> </tr> <tr> <td>City:</td> <td>Santa Clara</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>95054</td> </tr> </table>		Name:	SUN MICROSYSTEMS, INC.	Street Address:	4150 Network Circle	City:	Santa Clara	State/Country:	CALIFORNIA	Postal Code:	95054
Name:	SUN MICROSYSTEMS, INC.										
Street Address:	4150 Network Circle										
City:	Santa Clara										
State/Country:	CALIFORNIA										
Postal Code:	95054										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12687633</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12687633						
Property Type	Number										
Application Number:	12687633										
CORRESPONDENCE DATA											
<p>Fax Number: (530)759-1665 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 530-759-1663</p> <p>Email: edward@parklegal.com</p> <p>Correspondent Name: Edward J. Grundler</p> <p>Address Line 1: Park, Vaughan & Fleming, LLP</p> <p>Address Line 2: 2820 Fifth Street</p> <p>Address Line 4: Davis, CALIFORNIA 95618</p>											
ATTORNEY DOCKET NUMBER:	SUN10-0193										
NAME OF SUBMITTER:	Edward J. Grundler, Reg. No. 47,615										
<p>Total Attachments: 2 source=SUN10-0193_Assignment#page1.tif</p>											

OP \$40.00 12687633

501115502

PATENT
REEL: 024060 FRAME: 0853

CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

Xuezhe Zheng
Ashok V. Krishnamoorthy
John E. Cunningham

12442 Dormouse Road, San Diego, CA 92129
16132 Cayenne Creek Road, San Diego, CA 92127
12218 Carmel Vista Road, Apt. 233, San Diego, CA 92130

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

ELECTRO-OPTIC MODULATOR WITH INVERSE TAPERED WAVEGUIDES

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

___ On the ___ day of ___, 20___;

Or

X Said application having Application Number 12/687,633, and filed on 14 January; and 2010

WHEREAS, SUN MICROSYSTEMS, INC. a corporation of the State of Delaware, having a place of business at 4150 Network Circle, Santa Clara, CA 95054, (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use

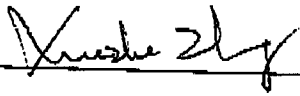
Attorney Docket No. SUN10-0193

proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

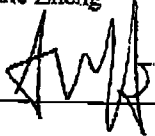
IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.



Xuezhe Zheng

11/13/2010

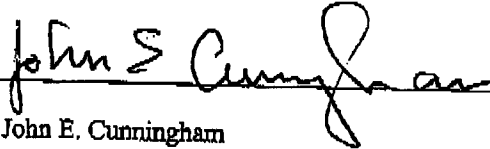
Date



Ashok V. Krishnamoorthy

11/13/2010

Date



John E. Cunningham

11/13/2010

Date

Date

Date